AAP Gen 7 (TO-240AA) Power Modules Thyristor/Diode and Thyristor/Thyristor, 27 A



ADD-A-PAK

| PRIMARY CHARACTERISTICS | | | | |
|--|-------------------------------|--|--|--|
| I _{T(AV)} or I _{F(AV)} | 27 A | | | |
| Туре | Modules - thyristor, standard | | | |
| Package | AAP Gen 7 (TO-240AA) | | | |

MECHANICAL DESCRIPTION

The AAP Gen 7 (TO-240AA), new generation of APP module, combines the excellent thermal performances obtained by the usage of exposed direct bonded copper substrate, with advanced compact simple package solution and simplified internal structure with minimized number of interfaces.

FEATURES

- · High voltage
- · Industrial standard package
- UL approved file E78996



- · Low thermal resistance
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Excellent thermal performances obtained by the usage of exposed direct bonded copper substrate
- Up to 1600 V
- High surge capability
- Easy mounting on heatsink

ELECTRICAL DESCRIPTION

These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, temperature and motor speed control circuits, UPS and battery charger.

| MAJOR RATINGS AND CHARACTERISTICS | | | | | |
|--|-----------------|-------------|-------------------|--|--|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS | | |
| I _{T(AV)} or I _{F(AV)} | 85 °C | 27 | | | |
| I _{O(RMS)} | As AC switch | 60 | ۸ | | |
| I _{TSM,} | 50 Hz | 400 | A | | |
| I _{FSM} | 60 Hz | 420 | | | |
| I ² t | 50 Hz | 800 | kA ² s | | |
| 1-1 | 60 Hz | 730 | KA-S | | |
| I ² √t | | 8000 | kA²√s | | |
| V _{RRM} | Range | 400 to 1600 | V | | |
| T _{Stg} | | -40 to +125 | °C | | |
| T _J | | -40 to +125 | °C | | |

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ELECTRICAL SPECIFICATIONS

| VOLTAGE RATINGS | | | | | | |
|-----------------|-----------------|---|---|--|---|--|
| TYPE NUMBER | VOLTAGE CODE | V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | V _{DRM} , MAXIMUM REPETITIVE PEAK OFF-STATE VOLTAGE, GATE OPEN CIRCUIT V | I _{RRM,} I _{DRM} AT 125 °C mA | |
| | 04 | 400 | 500 | 400 | | |
| | 06 | 600 | 700 | 600 | | |
| | 08 | 800 | 900 | 800 | | |
| VS-VSK.26 | 10 | 1000 | 1100 | 1000 | 15 | |
| | 12 | 1200 | 1300 | 1200 | | |
| | 14 | 1400 | 1500 | 1400 | | |
| | 16 | 1600 | 1700 | 1600 | | |

| ON-STATE CONDUCTION | | | | | | |
|--|----------------------------------|---|--|-----------------------------|--------|------------------|
| PARAMETER | SYMBOL | | TEST CONDITIONS | | VALUES | UNITS |
| Maximum average on-state current (thyristors) | I _{T(AV)} | 180° conduction | 180° conduction, half sine wave, | | 27 | |
| Maximum average forward current (diodes) | I _{F(AV)} | $T_C = 85 ^{\circ}C$ | | | 21 | |
| Maximum continuous RMS on-state current, as AC switch | I _{O(RMS)} | - | or ° | I _(RMS) | 60 | Α |
| | | t = 10 ms | No voltage | | 400 | |
| Maximum peak, one-cycle non-repetitive | I _{TSM} | t = 8.3 ms | reapplied | Sinusoidal half wave, | 420 | |
| on-state or forward current | or I _{FSM} | t = 10 ms | 100 % V _{RRM} | initial $T_J = T_J$ maximum | 335 | |
| | T OW | t = 8.3 ms | reapplied | 0 0 | 350 | |
| | l ² t | t = 10 ms | No voltage | | 800 | A ² s |
| Maximum I ² t for fusing | | t = 8.3 ms | reapplied | latified T. T. massins and | 730 | |
| | | t = 10 ms | 100 % V _{RRM} | Initial $T_J = T_J$ maximum | 560 | |
| | | t = 8.3 ms | reapplied | | 510 | |
| Maximum $I^2\sqrt{t}$ for fusing | I ² √t ⁽¹⁾ | | t = 0.1 ms to 10 ms, no voltage reapplied $T_J = T_J$ maximum | | | A²√s |
| Maximum value or threshold voltage | V _{T(TO)} (2) | Low level $^{(3)}$ $T_J = T_J \text{ maximum}$ | | au ma | 0.86 | V |
| waximum value or threshold voltage | VT(TO) (-) | High level (4) | ıj= ıjınaxın | IUIII | 1.09 | V |
| Maximum value of on-state | r _t ⁽²⁾ | Low level (3) | T. – T. mayin | auma | 9.58 | mΩ |
| slope resistance | 't (-) | High level (4) | $T_J = T_J$ maximum | | 7.31 | 11122 |
| Maximum peak on-state or forward voltage | V_{TM} | $I_{TM} = \pi \times I_{T(AV)}$ | T _ 05 °C | | 1.65 | V |
| Maximum peak on-state or forward voltage | V_{FM} | $I_{FM} = \pi \times I_{F(AV)}$ $T_{J} = 25 \text{ °C}$ | | 1.05 | V | |
| Maximum non-repetitive rate of rise of turned on current | dl/dt | $T_J = 25$ °C, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_q = 500$ mA, $t_r < 0.5$ μ s, $t_p > 6$ μ s | | | 150 | A/μs |
| Maximum holding current | I _H | T _J = 25 °C, anode supply = 6 V, resistive load, gate open circuit | | | 200 | mA |
| Maximum latching current | ΙL | T _J = 25 °C, and | ode supply = 6 | V, resistive load | 400 | |

Notes

⁽¹⁾ I^2t for time $t_x = I^2\sqrt{t} \times \sqrt{t_x}$

⁽²⁾ Average power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$

^{(3) 16.7 %} $\times \pi \times I_{AV} < I < \pi \times I_{AV}$

 $^{^{(4)}~}I>\pi~x~I_{AV}$

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| TRIGGERING | | | | | | |
|--|--------------------|---|-----------------------------------|--------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS | |
| Maximum peak gate power | P _{GM} | | | 10 | W | |
| Maximum average gate power | P _{G(AV)} | | | 2.5 | VV | |
| Maximum peak gate current | I _{GM} | | | 2.5 | Α | |
| Maximum peak negative gate voltage | -V _{GM} | | | 10 | | |
| Maximum gate voltage required to trigger | V _{GT} | T _J = -40 °C | Anode supply = 6 V | 4.0 | V | |
| | | T _J = 25 °C | | 2.5 | | |
| | | T _J = 125 °C | Tesistive load | 1.7 | | |
| | | T _J = -40 °C | | 270 | | |
| Maximum gate current required to trigger | I _{GT} | T _J = 25 °C | Anode supply = 6 V resistive load | 150 | mA | |
| | | T _J = 125 °C | Tesistive load | 80 | | |
| Maximum gate voltage that will not trigger | V_{GD} | T _J = 125 °C, rated V _{DRM} applied | | 0.25 | V | |
| Maximum gate current that will not trigger | I _{GD} | T _J = 125 °C, rated V _{DRI} | _M applied | 6 | mA | |

| BLOCKING | | | | |
|---|---------------------------------------|--|----------------------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Maximum peak reverse and off-state leakage current at V _{RRM} , V _{DRM} | I _{RRM,} I _{DRM} | T _J = 125 °C, gate open circuit | 15 | mA |
| Maximum RMS insulation voltage | V _{INS} | 50 Hz | 3000 (1 min) 3600 (1 s) | V |
| Maximum critical rate of rise of off-state voltage | dV/dt | $T_J = 125$ °C, linear to 0.67 V_{DRM} | 1000 | V/µs |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | |
|--|-------|-----------------------------------|---|-------------|------------|--|
| PARAMETER | | SYMBOL | TEST CONDITIONS | VALUES | UNITS | |
| Junction operating and storage temperature range | | T _J , T _{Stg} | | -40 to +125 | °C | |
| Maximum internal thermal resist junction to case per leg | ance, | R _{thJC} | DC operation | 0.76 | °C/W | |
| Typical thermal resistance, case to heatsink per module | • | | Mounting surface flat, smooth and greased | 0.1 | C/VV | |
| Mounting torque ± 10 % to heatsink busbar | | | A mounting compound is recommended and the torque should be rechecked after a period of | 4 | Nm | |
| | | | 3 hours to allow for the spread of the compound. | 3 | INIII | |
| Approximate weight | | | | 75 | g | |
| | | | | 2.7 | OZ. | |
| Case style | | | JEDEC® | AAP Gen 7 | (TO-240AA) | |

| ∆R CONDU | CTION F | ER JUN | CTION | | | | | | | | |
|----------|---------|-----------|---------|----------|------|-------|---------|-----------|------------|-------|-------|
| DEVICES | 5 | SINE HALF | WAVE CO | NDUCTION | N | RE | CTANGUL | AR WAVE C | CONDUCTION | NC | UNITS |
| DEVICES | 180° | 120° | 90° | 60° | 30° | 180° | 120° | 90° | 60° | 30° | UNITS |
| VSK.26 | 0.212 | 0.258 | 0.330 | 0.466 | 0.72 | 0.166 | 0.276 | 0.357 | 0.482 | 0.726 | °C/W |

Note

• Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

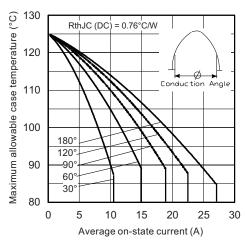


Fig. 1 - Current Ratings Characteristics

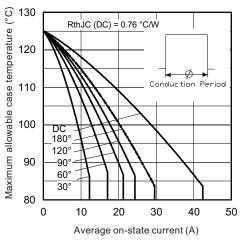


Fig. 2 - Current Ratings Characteristics

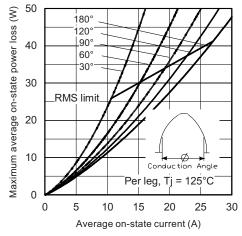


Fig. 3 - On-State Power Loss Characteristics

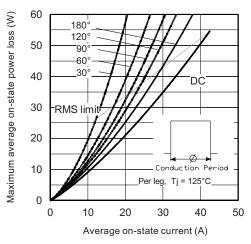
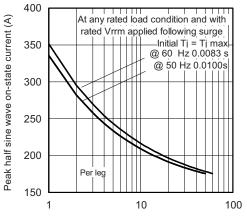


Fig. 4 - On-State Power Loss Characteristics



Number of equal amplitude half cycle current pulses (N)

Fig. 5 - Maximum Non-Repetitive Surge Current

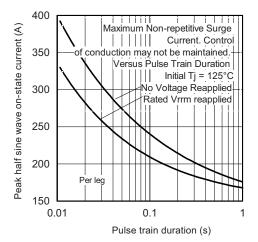


Fig. 6 - Maximum Non-Repetitive Surge Current

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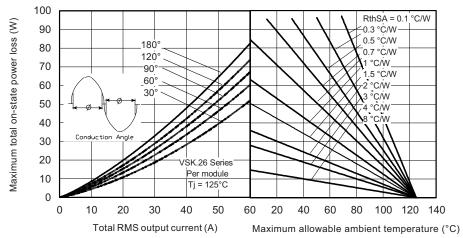


Fig. 7 - On-State Power Loss Characteristics

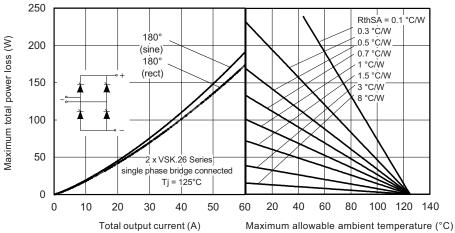


Fig. 8 - On-State Power Loss Characteristics

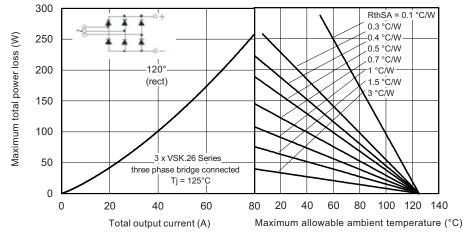


Fig. 9 - On-State Power Loss Characteristics

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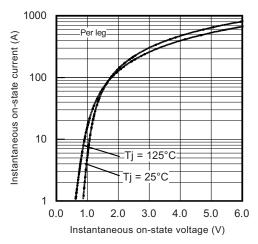


Fig. 10 - On-State Voltage Drop Characteristics

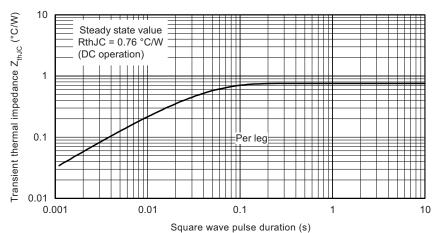


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics

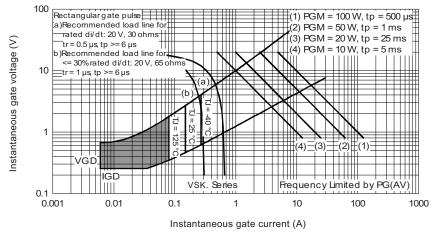
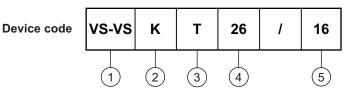


Fig. 12 - Gate Characteristics

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ORDERING INFORMATION TABLE



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Module type

Circuit configuration (see Circuit Configuration table)

Current code (26 A)

Voltage code (see Voltage Ratings table)

Note

To order the optional hardware go to www.vishay.com/doc?95172

| CIRCUIT DESCRIPTION | CIRCUIT CONFIGURATION CODE | CIRCUIT DRAWING |
|---|----------------------------|---|
| Two SCRs doubler circuit | Т | VSKT (1) |
| SCR/diode doubler circuit, positive control | Н | VSKH (1) (1) (2) (2) (3) (3) (3) (3) (4) (4) (5) |
| SCR/diode doubler circuit, negative control | L | VSKL (1) 1 2 2 2 (2) (3) (3) (4) (5) (6) (7) (6) |

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| CIRCUIT CONFIGURATION | CIRCUIT CONFIGURATION | | | | | | |
|--------------------------|----------------------------|---|--|--|--|--|--|
| CIRCUIT DESCRIPTION | CIRCUIT CONFIGURATION CODE | CIRCUIT DRAWING | | | | | |
| SCR/diode common anodes | N | VSKN (1) (2) (3) (3) (4) (5) | | | | | |
| Two SCRs common cathodes | U | VSKU (1) 1 (2) (2) (3) (3) (6) (7) (6) | | | | | |
| Two SCRs common anodes | V | VSKV (1) 1 (2) (2) (3) (3) (4) (5) (7) (6) | | | | | |

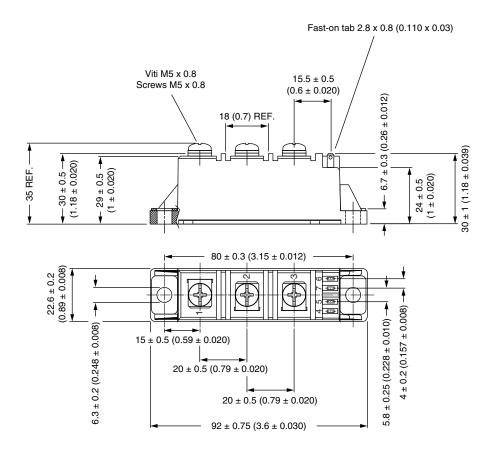
| LINKS TO RELAT | ED DOCUMENTS |
|----------------|--------------------------|
| Dimensions | www.vishay.com/doc?95368 |



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ADD-A-PAK Generation VII - Thyristor

DIMENSIONS in millimeters (inches)





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